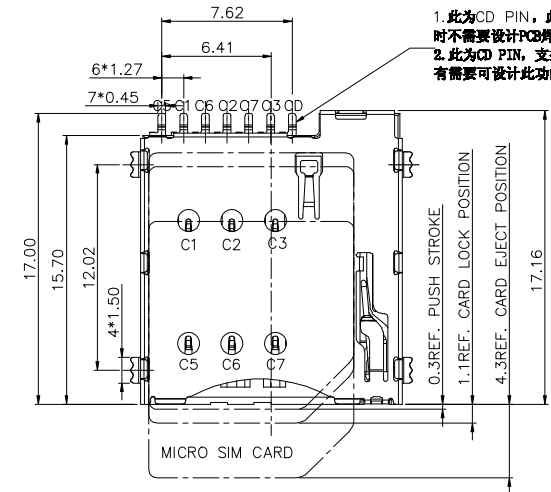
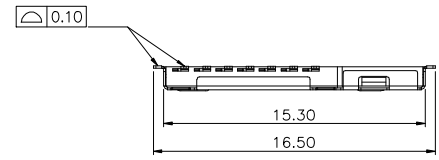
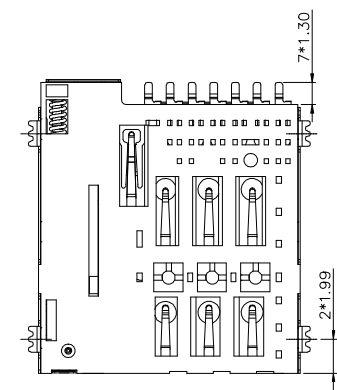
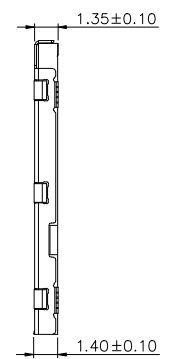


REV	DATE	ECN NO.	MODIFICATION	APPROVER
A	2016/10/14		NEW	Jason_Lee

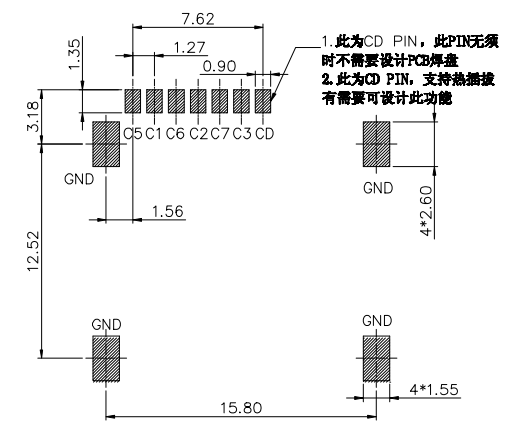
NOTES:
MATERIAL:
Housing: High Temperature thermoplastic,UL94V-0
Terminal:Copper Alloy
Shell:Stainless
SPECIALITY:
Rated Current:0.5A MAX
Rated Voltage:50V
Ambient Temperature Range: -20°C~+60°C
storageTemperature Range: -40°C~+70°C
Ambient Humidity Range :95% R.H. Max.
Contact Resistance:100mΩ Max
Insulation Resistance:1000MΩ/250V DC
Dielectric Withstanding Voltage:500V AC
Durability:5000 cycles
Temperature 260±5°C,



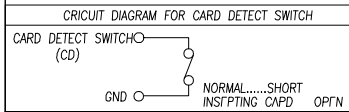
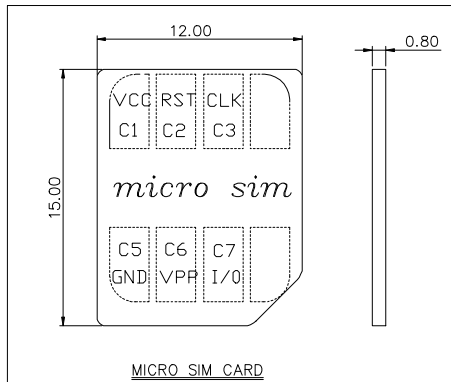
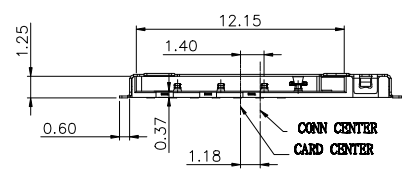
1.此为CD PIN, 此PIN无须
时不需要设计PCB焊盘
2.此为CD PIN, 支持热插拔
有需要可设计此功能



IM pin Assignment	
IN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



■ SMT SOLDER AREA
THERE SHOULD NOT BE ANY CIRCUITRIES
IN THE LAYOUT SPACE OF THE PRODUCTS
RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE±0.05



GENERAL TOLERANCE				UNITS mm	NAME: MICRO SIM CARD 6P PUSH PUSH		ATOM [®] 深圳市爱特姆科技有限公司 SHENZHEN ATOM TECHNOLOGY CO.,LTD.			
SELECT			✓		MAT'L	PART NO: SI62C-01200	TITLE: MICRO SIM CARD 6P PUSH PUSH SMT H=1.35mm 带检测脚 无柱			
TOL.	1	2	3							
ON.	±0.10	±0.05	±0.15							
X.XXX										
X.XX	±0.15	±0.13	±0.25	FINISH	APPD:	JASON	DWG NO. ATOM-A03337			
X.X	±0.20	±0.25	±0.5		CHKD:	XH		SCALE	SHEET	REV
X.	±0.30	±0.35	±1.00	Q'TY	DR:	JACK		1:1	1/1	A
ANGLE	±2°									